

1.6x0.8x0.5mm BI-COLOR SURFACE MOUNT **LED**



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Part Number: APHB1608QBDSURKC

Blue Hyper Red

Features

- 1.6mmX0.8mm SMT LED, 0.5mm thickness.
- · Compatible with reflow soldering.
- Available in various color combination.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

Description

The Blue source color devices are made with InGaN Light Emitting Diode.

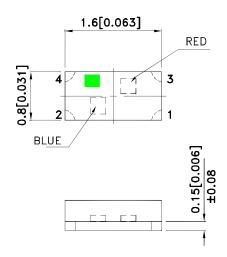
The Hyper Red source color devices are made with Al-GaInP on GaAs substrate Light Emitting Diode.

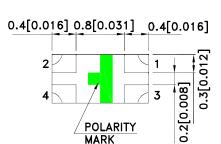
Static electricity and surge damage the LEDS.

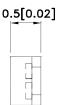
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

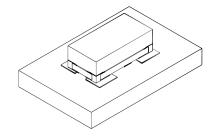
Package Dimensions











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.





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Selection Guide

| Part No. | Dice | Lens Type | lv (mcd) [2] @ 20mA | | Viewing Angle [1] |
|------------------|---------------------|-------------|------------------------|------|----------------------|
| | | ,. | Min. | Тур. | 201/2 |
| APHB1608QBDSURKC | Blue (InGaN) | Water Clear | 50 | 70 | - 130° |
| | Hyper Red (AlGalnP) | Water Clear | 120 | 250 | |

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter | Device | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|-------------------|-------------|----------|-----------|---------------------|
| λpeak | Peak Wavelength | Blue Hyper Red | 468 650 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Blue Hyper Red | 470 630 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Blue Hyper Red | 25 28 | | nm | IF=20mA |
| С | Capacitance | Blue Hyper Red | 100 35 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Blue Hyper Red | 3.3 1.95 | 4 2.5 | V IF=20mA | |
| lR | Reverse Current | Blue Hyper Red | | 50 10 | uA | V _R = 5V |

Notes:

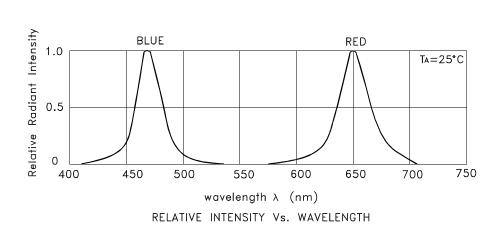
- 1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

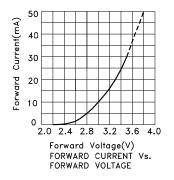
| Parameter | Blue | Hyper Red | Units | | |
|--------------------------|----------------|-----------|-------|--|--|
| Power dissipation | 120 | 75 | mW | | |
| DC Forward Current | 30 | 30 | mA | | |
| Peak Forward Current [1] | 150 | 185 | mA | | |
| Reverse Voltage | | V | | | |
| Operating Temperature | -40°C To +85°C | | | | |
| Storage Temperature | -40°C To +85°C | | | | |

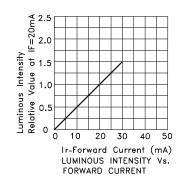
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

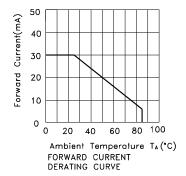
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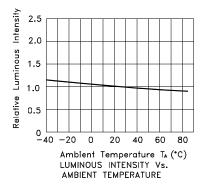


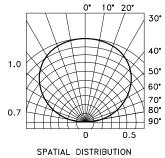
APHB1608QBDSURKC Blue







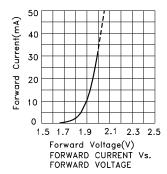


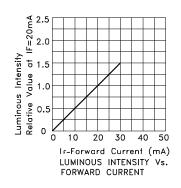


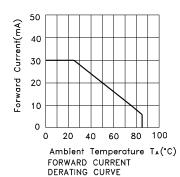
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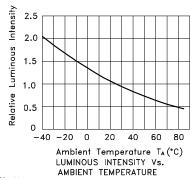
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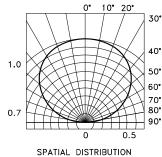
Hyper Red











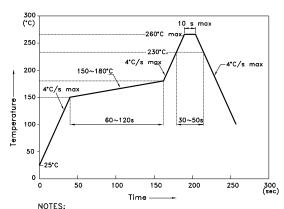
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



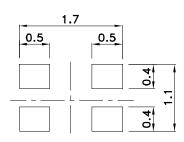
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

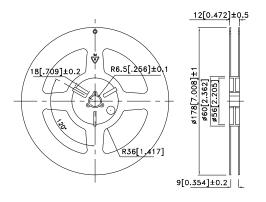
 3.Number of reflow process shall be 2 times or less.

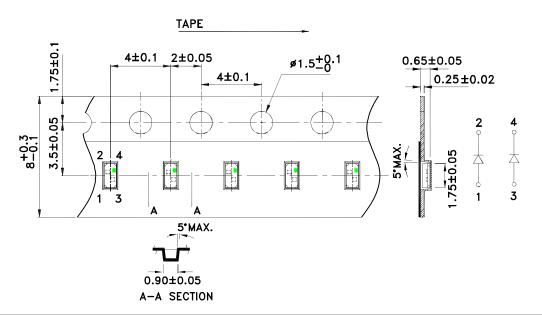
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units: mm)

Reel Dimension





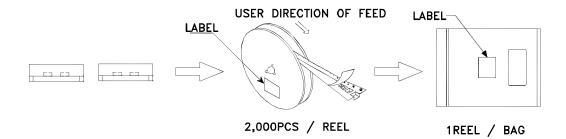
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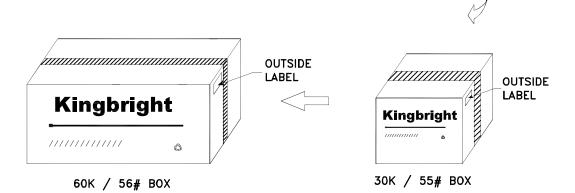
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PACKING & LABEL SPECIFICATIONS

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